

EPF6024ABC256-1

est a Quote

EPF6024ABC256-1 Information

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	Manufacturer	Intel	_
	Category	Integrated Circuits (ICs) Embedded - FPGAs (Field Programmable Gate Array)	
	Description	IC FPGA 218 I/O 256BGA	- 3
	Package	256-BBGA	. E
For Reference Only		For the pricing/inventory/lead time, please contact	_
		us Website: https://www.heisener.com	Т
		E-mail: salesdept@heisener.com	R

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



EPF6024ABC256-1 Specifications

Manufacturer Part Number	EPF6024ABC256-1
Manufacturer	Intel
Category	Integrated Circuits (ICs)
	Embedded - FPGAs (Field Programmable Gate Array)
Package	256-BBGA
Series	FLEX 6000
Number of LABs/CLBs	196
Number of Logic Elements/Cells	1960
Total RAM Bits	-
Number of I/O	218
Number of Gates	24000
Voltage - Supply	3 V ~ 3.6 V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BBGA
Supplier Device Package	256-BGA (27x27)
	Report errors?

EPF6024ABC256-1 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

EPF6024ABC256-1 Payment Methods



EPF6024ABC256-1 Shipping Methods



If you have any question about EPF6024ABC256-1, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com